

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHI-CHUAN CHUANG	08/14/2014
YI-HSIANG LAI	08/14/2014
JIE-HONG CHIANG	08/13/2014
RECEIVING PARTY DATA	
Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
Street Address:	NO. 8, LI-HSIN RD. VI, HSINCHU SCIENCE PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300
Name:	NATIONAL TAIWAN UNIVERSITY
Street Address:	NO. 1, SEC. 4, ROOSEVELT RD., ZHONGZHENG DIST.
City:	TAIPEI CITY
State/Country:	TAIWAN
Postal Code:	100
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16700984
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NAME OF SUBMITTER:	RANDY A. NORANBROCK

SIGNATURE:	/Randy A. Noranbrock/
DATE SIGNED:	12/02/2019
Total Attachments: 1 source=EfiledAssgn#page1.tif	

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- 1) Chi-Chuan CHUANG 3) Jie-Hong CHIANG
2) Yi-Hsiang LAI

who has made a certain new and useful invention, hereby sells, assigns and transfers unto TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD., having a place of business at No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu 300, Taiwan R.O.C. and NATIONAL TAIWAN UNIVERSITY, having a place of business at No. 1, Sec. 4, Roosevelt Rd., Zhongzheng Dist., Taipei City 100, Taiwan (R.O.C.)

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

LOGIC CIRCUIT AND SYSTEM AND COMPUTER PROGRAM PRODUCT FOR LOGIC SYNTHESIS

- (a) for which an application for United States Letters Patent was filed on 2014-08-20, and identified by United States Patent Application No. 14/464,366; or
(b) for which an application for United States Letters Patent was executed on _____,

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

- 1) Chi-Chuan Chuang
Name: Chi-Chuan CHUANG
2) Yi Hsiang Lai
Name: Yi-Hsiang LAI
3) Jie Hong Jiang
Name: Jie-Hong CHIANG

2014/8/14
Date:
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